

Appl. No. 09/751,215  
Amendment dated February 4, 2004  
Reply to Office Action of November 5, 2003



Attorney's Docket No.: 42390.P10048

Patent

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:

Andrew Yeoh

U.S. Serial No: 09/751,215

Filed: December 29, 2000

For: HARDENING OF COPPER TO IMPROVE  
COPPER CMP PERFORMANCE

Mail Stop Non-Fee Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Examiner: Vu, Hung K.

Art Unit: 2811

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**AMENDMENT AND RESPONSE**

Dear Sir:

This is in response to the Office Action mailed November 5, 2003. Applicant respectfully requests the Examiner to consider the following remarks.

**FIRST CLASS CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on February 4, 2004

Date of Deposit

Claire Walters

Name of Person Mailing Correspondence

*Claire Walters*

Signature

*2/4/2004*

Date